

# LCD Segment Drivers Multi-function LCD Segment Drivers

BU97520AKV-M

MAX 276 Segment(69SEG x 4COM)

#### **General Description**

The BU97520AKV-M is 1/4 or 1/3-Duty general-purpose LCD driver that can be used for frequency display in electronic tuners under the control of a microcontroller. The BU97520AKV-M can drive up to 276 LCD Segments directly. The BU97520AKV-M can also control up to 6 general-purpose output ports. These products also incorporate a key scan circuit that accepts input from up to 30 keys to reduce printed circuit board wiring.

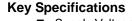
#### Features

- AEC-Q100 Qualified (Note1)
- Key input function for up to 30 keys. (A key scan is performed only when a key is pressed.)
- Either 1/4 or 1/3-Duty can be selected with the serial control data.
  - 1/4-Duty drive: Up to 276 segments 1/3-Duty drive: Up to 207 segments
- Serial data control of frame frequency for common and segment output waveforms.
- Serial data control of switching between the segment output port , PWM output port and general-purpose output port functions.(Max 6 port)
- Built-in OSC circuit
- The INHb pin can force the display to the off state.
- Integrated Power-on Reset circuit
- No external component required
- Low power consumption design
- Supports Line and Frame Inversion (Note1) Grade 3

#### Applications

 Car audio, Home electrical appliance, Meter equipment etc.

#### **Typical Application Circuit**



- Supply Voltage Range:
- Operating Temperature Range:
- Max Segments:
- Display Duty:
- Bias:

Packages

Interface:

+2.7V to +6.0V

-40°C to +85°C

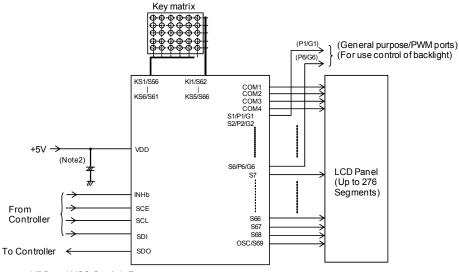
276 Segments

1/3. 1/4 selectable

1/2, 1/3 selectable

3wire serial interface



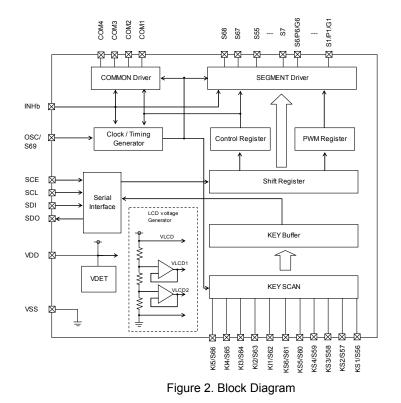


(Note2) Insert capacitors between VDD and VSS C >  $0.1 \mu$ F.

Figure 1. Typical Application Circuit

OProduct structure : Silicon monolithic integrated circuit OThis product is not designed protection against radioactive rays

#### **Block Diagram**



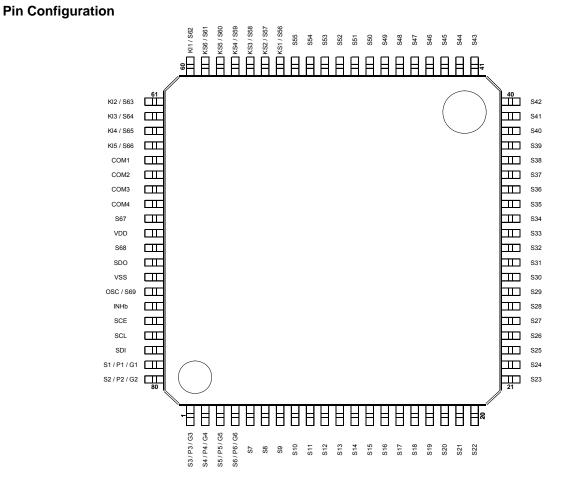


Figure 3. Pin Configuration (TOP VIEW)

#### Absolute Maximum Ratings (Ta = 25°C, VSS = 0V)

Parameter	Symbol	Conditions	Rating	Unit
Maximum Supply Voltage	VDD max	VDD	-0.3 to +6.5	V
Input Voltage	VIN1	SCE, SCL, SDI, INHb	-0.3 to +6.5	V
	VIN2	KI1 to KI5	-0.3 to +6.5	V
Allowable Loss	Pd		1.20 <sup>(Note3)</sup>	W
Operating Temperature	Topr		-40 to +85	°C
Storage Temperature	Tstg		-55 to +125	С°

(Note3) Derate by 12.0mW/°C when operating above Ta=25°C (when mounted in ROHM's standard board). **Caution:** Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

#### Recommended Operating Conditions (Ta = -40°C to 85°C, VSS = 0V)

Baramatar	Parameter Symbol Conditions			Lloit		
Farameter	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	VDD		2.7	5.0	6.0	V

#### Electrical Characteristics (Ta = -40°C to 85°C, VDD = 2.7V to 6.0V, VSS = 0V)

Parameter	Symbol	Pin	Conditions	Min	Limit	Max	Unit
Livotorogia	VH1	SCE, SCL, SDI,		Min	Тур	Max	
Hysteresis		INHb		-	0.03VDD	-	V
	VH2	KI1 to KI5		-	0.1VDD	-	V
Power-on Detection Voltage	VDET	VDD		1.4	1.8	2.2	V
"H" Level Input Voltage	VIH1	SCE,SCL,SDI,INHb	$4.0V \le VDD \le 6.0V$	0.4VDD	-	VDD	V
	VIH2	SCE,SCL,SDI,INHb	2.7V ≤ VDD < 4.0V	0.8VDD	-	VDD	
	VIH3	KI1 to KI5		0.7VDD	-	VDD	
"L" Level Input Voltage	VIL1	SCE,SCL,SDI,INHb KI1 to KI5		0	-	0.2VDD	V
Input Floating Voltage	VIF	KI1 to KI5		-	-	0.05VDD	V
Pull-down Resistance	RPD	KI1 to KI5	VDD=5.0V	50	100	250	KΩ
Output Off Leakage Current	IOFFH	SDO	VO=6.0V	-	-	6.0	uA
"H" Level Input Current	IIH1	SCE,SCL,SDI,INHb	VI = 5.5V	-	-	5.0	μA
"L" Level Input Current	IIL1	SCE,SCL,SDI,INHb	VI = 0V	-5.0	-	-	μA
"H" Level	VOH1	S1 to S69	IO = -20µA	VDD-0.9	-	-	
Output Voltage	VOH2	COM1 to COM4	IO = -100µA	VDD-0.9	-	-	
	VOH3	P1/G1 to P6/G6	IO = -1mA	VDD-0.9	-	-	V
	VOH4	KS1 to KS6	IO = -500uA	VDD-1.0	VDD-0.5	VDD-0.2	
"L" Level	VOL1	S1 to S69	IO = 20µA	-	-	0.9	
Output Voltage	VOL2	COM1 to COM4	IO = 100µA	-	-	0.9	
	VOL3	P1/G1 to P6/G6	IO = 1mA	-	-	0.9	V
	VOL4	KS1 to KS6	IO = 25uA	0.2	0.5	1.5	
	VOL5	SDO	IO = 1mA	-	0.1	0.5	
Middle Level	VMID1	S1 to S69	1/2-Bias IO = ±20µA	1/2VDD		1/2VDD	
Output Voltage				-0.9	-	+0.9	
	VMID2	COM1	1/2-Bias IO = ±100µA	1/2VDD		1/2VDD	
		to COM4		-0.9	-	+0.9	
	VMID3	S1 to S69	1/3-Bias IO = ±20µA	2/3VDD		2/3VDD	
				-0.9	-	+0.9	v
	VMID4	S1 to S69	1/3-Bias IO = ±20µA	1/3VDD	_	1/3VDD	v
				-0.9	_	+0.9	
	VMID5	COM1	1/3-Bias IO = ±100µA	2/3VDD	_	2/3VDD	
		to COM4		-0.9		+0.9	
	VMID6	COM1	1/3-Bias IO = ±100µA	1/3VDD	_	1/3VDD	
		to COM4		-0.9		+0.9	
Current Consumption	IDD1	VDD	Power-saving mode	-	-	15	
	IDD2	VDD	VDD = 5.0V				
			Output open 1/2-Bias Frame frequency = 80Hz	-	85	170	μA
	IDD3	VDD	VDD = 5.0V Output open 1/3-Bias Frame frequency = 80Hz	-	110	210	. Par .

#### Oscillation Characteristics(Ta = -40°C to 85°C, VDD = 2.7V to 6.0V , VSS = 0V)

Parameter	Symbol	Pin	Conditions		Limit		Unit
Falameter	Symbol	FIII	Conditions	Min	Тур	Max	Unit
Oscillator Frequency 1	fosc1	-	VDD = 2.7V to 6.0V	300	-	720	kHz
Oscillator Frequency 2	fosc2	-	VDD = 5V	510	600	690	kHz
External Clock Frequency (Note4)	fosc3	OSC	External clock mode (OC=1)	30	-	1000	kHz
External Clock Duty	tdty	OSC	External clock mode (OC=1)	30	50	70	%

(Note4) Frame frequency is decided by external frequency and dividing ratio of FC0, FC1, FC2 setting.

#### [Reference Data]

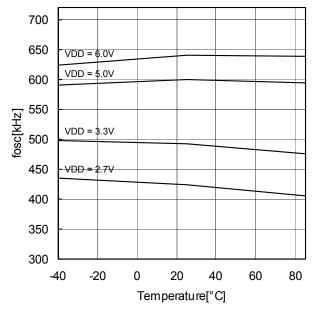


Figure 4. Typical Temperature Characteristics

#### MPU Interface Characteristics (Ta = -40°C to 85°C, VDD = 2.7V to 6.0V, VSS = 0V)

Parameter	Symbol	Pin	Conditions		Unit		
Parameter	Symbol	PIII	Conditions	Conditions Min		Max	Unit
Data Setup Time	tds	SCL, SDI		120	-	-	ns
Data Hold Time	tdh	SCL, SDI		120	-	-	ns
SCE Wait Time	tcp	SCE, SCL		120	-	-	ns
SCE Setup Time	tcs	SCE, SCL		120	-	-	ns
SCE Hold Time	tch	SCE, SCL		120	-	-	ns
Clock Cycle Time	tccyc	SCL		320	-	-	ns
High-level Clock Pulse Width	tchw	SCL		120	-	-	ns
Low-Level Clock Pulse Width (Write)	tclww	SCL		120	-	-	ns
Low-Level Clock Pulse Width (Read)	tclwr	SCL	RPU=4.7KΩ CL=10pF <sup>(Note5)</sup>	1.6	-	-	us
Rise Time	tr	SCE, SCL, SDI		-	160	-	ns
Fall Time	tf	SCE, SCL, SDI		-	160	-	ns
INH Switching Time	tc	INHb, SCE		10	-	-	μs
SDO Output Delay Time	tdc	SDO	RPU=4.7KΩ CL=10pF <sup>(Note5)</sup>	-	-	1.5	μs
SDO Rise Time	tdr	SDO	RPU=4.7KΩ CL=10pF <sup>(Note5)</sup>	-	-	1.5	μs

(Note5) Since SDO is an open-drain output, "tdc" and "tdr" depend on the resistance of the pull-up resistor RPU and the load capacitance SCL.

RPU: 1kΩ≤RPU≤10kΩ is recommended. CL: A parasitic capacitance to VSS in an application circuit. Any component is not necessary to be attached.

Power supply for I/O level

#### 1. When SCL is stopped at the low level

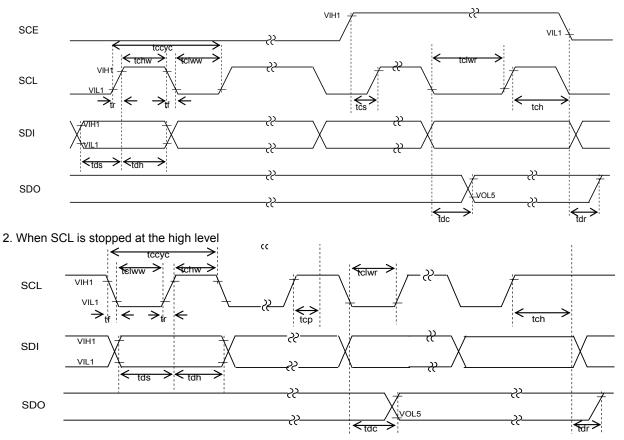


Figure	5.	Serial	Interface	Timing
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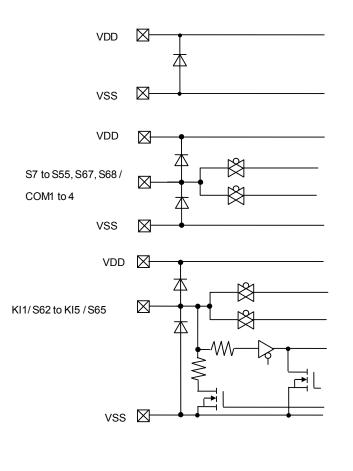
#### **Pin Description**

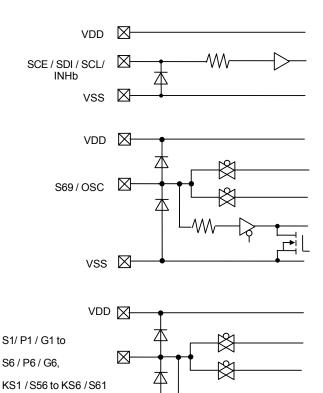
Fin Description		1		r	
Symbol	Pin No.	Function	Active	I/O	Handling when unused
S1/P1/G1 to S6/P6/G6	79,80, 1 to 4,	Segment output for displaying the display data transferred by serial data input. The S1/P1/G1 to S6/P6/G6 pins can also be used as General-purpose outputs when so set up by the control data.	-	0	OPEN
S7 to S55 S67,S68	5 to 53, 69,71	Segment output for displaying the display data transferred by serial data input.	-	0	OPEN
KS1/S56 to KS6/S61	54 to 59	Key scan outputs Although normal key scan timing lines require diodes to be inserted in the timing lines to prevent shorts, since these outputs are unbalanced CMOS transistor outputs, these outputs will not be damaged by shorting when these outputs are used to form a key matrix. The KS1/S56 to KS6/S61 pins can be used as segment outputs when so specified by the control data.	_	0	OPEN
KI1/S62 to KI5/S66	60 to 64	Key scan inputs These pins have built-in pull-down resistors. The KI1/S62 to KI5/S66 pins can be used as segment outputs when so specified by the control data.	-	I/O	OPEN
COM1 to COM4	65 to 68	Common driver output pins. The frame frequency is fo[Hz].	-	0	OPEN
S69/OSC	74	Segment output for displaying the display data transferred by serial data input. The pin S69/OSC can be used external frequency input pin when set up by the control data.	-	I/O	OPEN
SCE SCL SDI	76 77 78	Serial data transfer inputs. Must be connected to the controller. SCE: Chip enable SCL: Clock for serial data transfer. SDI: Transfer data	H 	   	GND
SDO	72	Output data	-	0	OPEN

### Datasheet

INHb	75	Display off control input. When INHb = low (VSS), Display forced off S1/P1/G1 to S6/P6/G6 = low (VSS) S7 to S69 = low (VSS) COM1 to COM4 = low (VSS) Stop the LCD drive bias voltage generation divider resistors.	L	I	VDD
		Stop the internal oscillation circuit. When INHb = high (VDD), Display on However, serial data transfer is possible when the display is forced off.			
VDD	70	Power supply pin. A supply voltage of 2.7V to 6.0V must be applied to this pin.	-	-	-
VSS	73	Power supply pin. Must be connected to ground.	-	-	-

#### **IO Equivalence Circuit**





vss 🛛

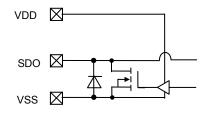
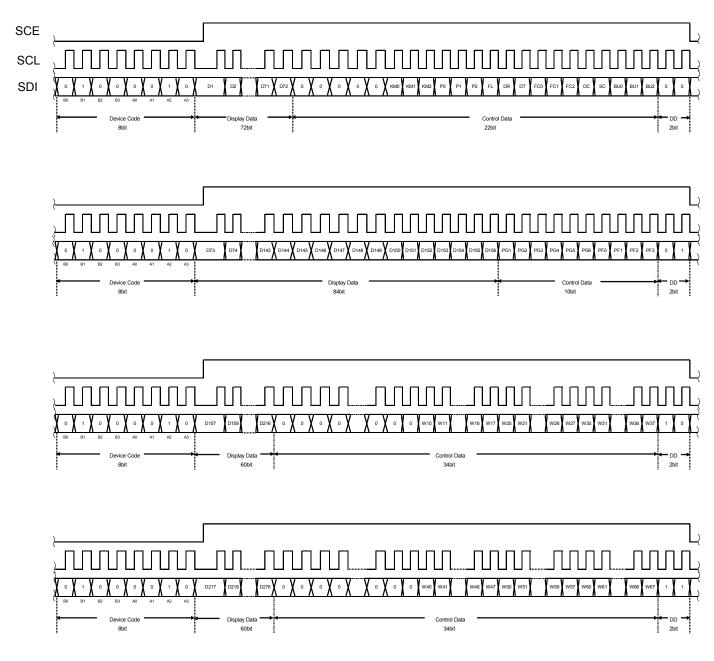


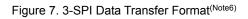
Figure 6. I/O Equivalence Circuit

#### **Serial Data Transfer Formats**

1. 1/4-Duty

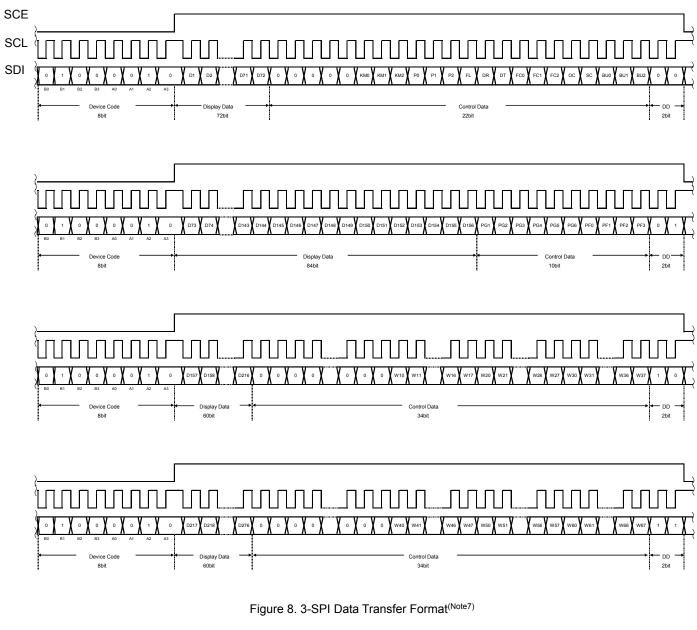
17. When SCL is stopped at the low level





(Note6) DD is direction data.

#### (2) When SCL is stopped at the high level



(Note7) DD is direction data.

Device code	- "42H"
D1 to D162	- Display data
KM0 to KM2	<ul> <li>Key Scan output port/Segment output port switching control data</li> </ul>
P0 to P2	<ul> <li>Segment output port/general-purpose output port switching control data</li> </ul>
FL	- Inversion type select control data
DR	- 1/3-Bias or 1/2-Bias drive switching control data
DT	1/4-Duty or 1/3-Duty drive switching control data
FC0 to FC2	- Common/segment output waveform frame frequency setting control data
OC	- Internal oscillator operating mode/External clock operating mode switching control data
SC	Segment on/off control data
BU0 to BU2	- Normal mode/power-saving mode control data
PG1 to PG6	PWM/General Purpose output select data
PF0 to PF3	PWM output waveform frame frequency setting control data.
Wn0 to Wn7 (n=1 to 6)	PWM output duty setting control data

2. 1/3-Duty

(1) When SCL is stopped at the low level

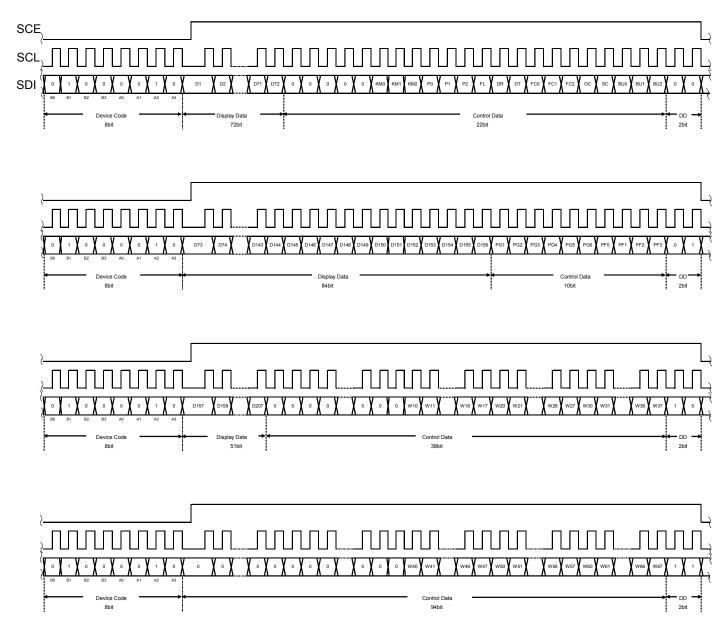
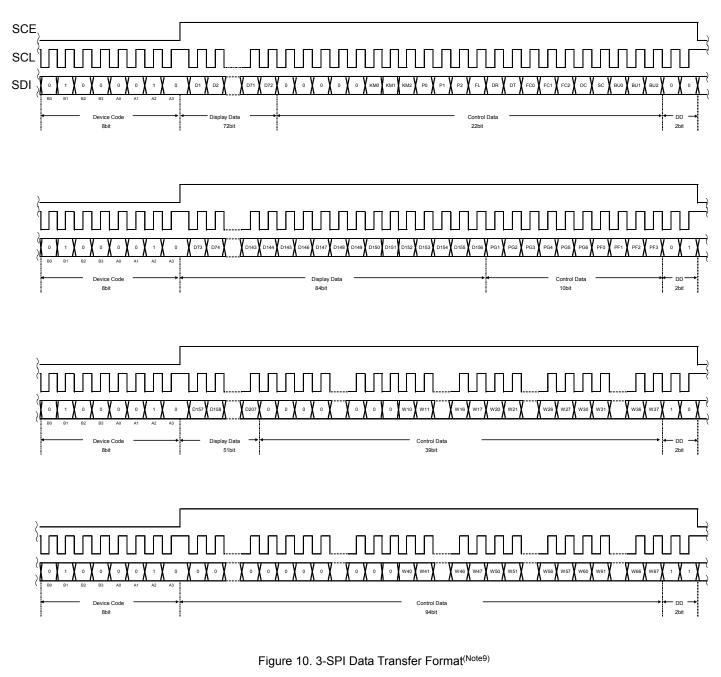


Figure 9. 3-SPI Data Transfer Format<sup>(Note8)</sup>

(Note8) DD is direction data.

(2) When SCL is stopped at the high level



(Note9) DD is direction data.

Device code	
D1 to D162	- Display data
KM0 to KM2	- Key Scan output port/Segment output port switching control data
P0 to P2	- Segment output port/general-purpose output port switching control data
FL	- Inversion type select control data
DR	- 1/3-Bias or 1/2-Bias drive switching control data
DT	<ul> <li>1/4-Duty or 1/3-Duty drive switching control data</li> </ul>
FC0 to FC2	<ul> <li>Common/segment output waveform frame frequency setting control data</li> </ul>
OC	- Internal oscillator operating mode/External clock operating mode switching control data
SC	Segment on/off control data
BU0 to BU2	<ul> <li>Normal mode/power-saving mode control data</li> </ul>
PG1 to PG6	PWM/General Purpose output select data
PF0 to PF3	PWM output waveform frame frequency setting control data.
Wn0 to Wn7 (n=1 to 6)	PWM output duty setting control data

#### **Control Data Functions**

17. KM0 to KM2: Key Scan output port/Segment output port control data

These control data bits switch the functions of the KS1/S56 to KS6/S61 output pins between key scan output and segment output.

KM0	KM1	KM2	Output Pin State					Maximum Number	
KIVIU		r\iviz	KS1/S56	KS2/S57	KS3/S58	KS4/S59	KS5/S60	KS6/S61	of Input keys
0	0	0	KS1	KS2	KS3	KS4	KS5	KS6	30
0	0	1	S56	KS2	KS3	KS4	KS5	KS6	25
0	1	0	S56	S57	KS3	KS4	KS5	KS6	20
0	1	1	S56	S57	S58	KS4	KS5	KS6	15
1	0	0	S56	S57	S58	S59	KS5	KS6	10
1	0	1	S56	S57	S58	S59	S60	KS6	5
1	1	0	S56	S57	S58	S59	S60	S61	0
1	1	1	S56	S57	S58	S59	S60	S61	0

2. P0 to P2: Segment / PWM / General Purpose output port control data

These control bits are used to select the function of the S1/P1 to S6/P6 output pins (Segment Output Pins or PWM Output Pins or General Purpose Output Pins).

P0	P1	P2	S1/P1/G1	S2/P2/G2	S3/P3/G3	S4/P4/G4	S5/P5/G5	S6/P6/G6
0	0	0	S1	S2	S3	S4	S5	S6
0	0	1	P1/G1	S2	S3	S4	S5	S6
0	1	0	P1/G1	P2/G2	S3	S4	S5	S6
0	1	1	P1/G1	P2/G2	P3/G3	S4	S5	S6
1	0	0	P1/G1	P2/G2	P3/G3	P4/G4	S5	S6
1	0	1	P1/G1	P2/G2	P3/G3	P4/G4	P5/G5	S6
1	1	0	P1/G1	P2/G2	P3/G3	P4/G4	P5/G5	P6/G6
1	1	1	S1	S2	S3	S4	S5	S6

PWM output or General Purpose output is selected by PGx (x=1 to 6) control data bit.

When the General Purpose Output Port Function is selected, the correspondence between the output pins and the respective display data is given in the table below.

Output Dipa	Corresponding Display Data				
Output Pins	1/4-Duty mode	1/3-Duty mode			
S1/P1/G1	D1	D1			
S2/P2/G2	D5	D4			
S3/P3/G3	D9	D7			
S4/P4/G4	D13	D10			
S5/P5/G5	D17	D13			
S6/P6/G6	D21	D16			

When the General Purpose Output Port Function is selected, the respective output pin outputs a "HIGH" level when its corresponding display data is set to "1". Likewise, it will output a "LOW" level, if its corresponding display data is set to "0". For example, S4/P4/G4 is used as a General Purpose Output Port in case of 1/4-Duty, if its corresponding display data – D13 is set to "1", then S4/P4/G4 will output "HIGH" level. Likewise, if D13 is set to "0", then S4/P4/G4 will output "LOW" level.

3. DR: 1/3-Bias drive or 1/2-Bias drive control data

This control data bit selects either 1/3-Bias drive or 1/2-Bias drive.

DR	Bias Drive Scheme
0	1/3-Bias drive
1	1/2-Bias drive

#### 4. FL: Line Inversion or Frame Inversion control data

This control data but selects either Line Inversion or Frame Inversion.

FL	Inversion Setting
0	Line
1	Frame

#### 5. DT: 1/4-Duty drive or 1/3-Duty drive control data

This control data bit selects either 1/4-Duty drive or 1/3-Duty drive.

DT	Duty Drive Scheme
0	1/4-Duty drive
1	1/3-Duty drive

6. FC0, FC1, FC2: Common/segment output waveform frame frequency control data

These control data bits set the frame frequency for common and segment output waveforms.						
FC0	FC1	FC2 Frame Frequency fo(Hz)				
0	0	0	fosc <sup>(Note10)</sup> /12288			
0	0	1	fosc/10752			
0	1	0	fosc/9216			
0	1	1	fosc/7680			
1	0	0	fosc/6144			
1	0	1	fosc/4608			
1	1	0	fosc/3840			
1	1	1	fosc/3072			

(Note10) fosc: Internal oscillation frequency (600 [kHz] typ.)

#### 7. OC: Internal oscillator operating mode/External clock operating mode control data

This control data bit selects the oscillation mode.

OC	Operating Mode	In/Out Pin(S69/OSC) Status
0	Internal oscillator	S69 (segment output)
1	External Clock	OSC (clock input)

#### 8. SC: Segment on/off control data

This control data bit controls the on/off state of the segments.

SC	Display State
0	On
1	Off
Note that when the ecomor	to are turned off by actting SC

Note that when the segments are turned off by setting SC to "1", the segments are turned off by outputting segment off waveforms from the segment output pins.

#### 9. BU: Normal mode/power-saving mode control data

This control data bit selects either normal mode or power-saving mode. Segment outputs Output Pin States During Key Scan Standby BU0 BU1 BU2 Mode **OSC** Oscillator Common outputs KS1 KS2 KS3 KS4 KS5 KS6 0 0 0 Normal Operating Operating Н Н Н Н Н Н 0 Н 0 1 L L L L L Н 0 1 0 L L Н L L Н Н 0 1 1 L L Н L Power-0 Н 1 0 Stopped Low(VSS) L. L. Η Н Н saving Н 1 0 1 Н Н н Н Т 1 1 0 Н Н Н Η Н Н 1 Η Н Н Η Н Н

Power-saving mode status:

S1/P1/G1 to S6/P6/G6 = active only General Purpose output

S7 to S69 = low(VSS)

COM1 to COM4 = low(VSS)

Stop the LCD drive bias voltage generation circuit

Stop the Internal oscillation circuit

However, serial data transfer is possible during Power-saving mode.

#### 10. PG1, PG2, PG3, PG4, PG5, PG6: PWM/General Purpose output control data

This control data bit select either PWM output or General Purpose output of Sx/Px/Gx pins.(x=1 to 6)

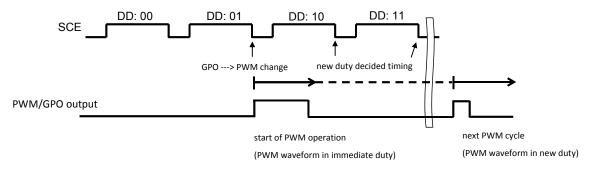
PGx(x=1 to 6)	Mode
0	PWM output
1	General Purpose output

<PWM<->GPO Changing function>

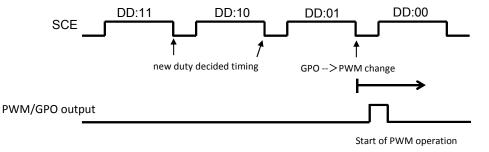
Normal behavior of changing GPO to PWM is below.

- PWM operation is started by command import timing of DD: 01 during GPO -→ PWM change.

- Please take care of reflect timing of new duty setting of DD: 10 and DD: 11 is from the next PWM.



In order to avoid this operation, please input commands in reverse as below.



(PWM waveform on new duty)

11. PF0, PF1, PF2, PF3: PWM output waveform frame frequency control data These control data bits set the frame frequency for PWM output waveforms.

These control data bits set the frame frequency for PVVN output waveforms.							
PF0	PF1	PF2	PF3	PWM output Frame Frequency fp(Hz)			
0	0	0	0	fosc/4096			
0	0	0	1	fosc/3840			
0	0	1	0	fosc/3584			
0	0	1	1	fosc/3328			
0	1	0	0	fosc/3072			
0	1	0	1	fosc/2816			
0	1	1	0	fosc/2560			
0	1	1	1	fosc/2304			
1	0	0	0	fosc/2048			
1	0	0	1	fosc/1792			
1	0	1	0	fosc/1536			
1	0	1	1	fosc/1280			
1	1	0	0	fosc/1024			
1	1	0	1	fosc/768			
1	1	1	0	fosc/512			
1	1	1	1	fosc/256			

12. W10 to W17<sup>(Note11)</sup>, W20 to W27, W30 to W37, W40 to W47, W50 to W57, W60 to W67: PWM output waveform duty control data.

These control data bits set the high level pulse width(duty) for PWM output waveforms.

Wn0	Wn1	Wn2	Wn3	Wn4	Wn5	Wn6	Wn7	N = 1 to 6, Tp = 1/ PWM Duty
0	0	0	0	0	0	0	0	(1/256) x Tp
0	0	0	0	0	0	0	1	(2/256) x Tp
0	0	0	0	0	0	1	0	(3/256) x Tp
0	0	0	0	0	0	1	1	(4/256) x Tp
0	0	0	0	0	1	0	0	(5/256) x Tp
0	0							
-		0	0	0	1	0	1	(6/256) x Tp
0	0	0	0	0	1	1	0	(7/256) x Tp
0	0	0	0	0	1	1	1	(8/256) x Tp
0	0	0	0	1	0	0	0	(9/256) x Tp
0	0	0	0	1	0	0	1	(10/256) x Tp
0	0	0	0	1	0	1	0	(11/256) x Tp
0	0	0	0	1	0	1	1	(12/256) x Tp
0	0	0	0	1	1	0	0	(13/256) x Tp
0	0	0	0	1	1	0	1	(14/256) x Tp
0	0	0	0	1	1	1	0	(15/256) x Tp
0	0	0	0	1	1	1	1	(16/256) x Tp
0	0	0	1	0	0	0	0	(17/256) x Tp
0	0	0	1	0	0	0	1	(18/256) x Tp
0	0	0	1	0	0	1	0	(19/256) x Tp
0	0	0	1	0	0	1	1	(20/256) x Tp
0	0	0	1	0	1	0	0	(21/256) x Tp
0	0	0	1	0	1	0	1	
		-						(22/256) x Tp
0	0	0	1	0	1	1	0	(23/256) x Tp
0	0	0	1	0	1	1	1	(24/256) x Tp
0	0	0	1	1	0	0	0	(25/256) x Tp
0	0	0	1	1	0	0	1	(26/256) x Tp
0	0	0	1	1	0	1	0	(27/256) x Tp
1	1	1	0	0	1	0	1	(230/256) x Tp
1	1	1	0	0	1	1	0	(231/256) x Tp
1	1	1	0	0	1	1	1	(232/256) x Tp
1	1	1	0	1	0	0	0	(233/256) x Tp
1	1	1	0	1	0	0	1	(234/256) x Tp
1	1	1	0	1	0	1	0	(235/256) x Tp
1	1	1	0	1	0	1	1	(236/256) x Tp
1	1	1	0	1	1	0	0	(237/256) x Tp
1	1	1		1	1	0	1	
			0					(238/256) x Tp
1	1	1	0	1	1	1	0	(239/256) x Tp
1	1	1	0	1	1	1	1	(240/256) x Tp
1	1	1	1	0	0	0	0	(241/256) x Tp
1	1	1	1	0	0	0	1	(242/256) x Tp
1	1	1	1	0	0	1	0	(243/256) x Tp
1	1	1	1	0	0	1	1	(244/256) x Tp
1	1	1	1	0	1	0	0	(245/256) x Tp
1	1	1	1	0	1	0	1	(246/256) x Tp
1	1	1	1	0	1	1	0	(247/256) x Tp
1	1	1	1	0	1	1	1	(248/256) x Tp
1	1	1	1	1	0	0	0	(249/256) x Tp
1	1	1	1	1	0	0	1	(250/256) x Tp
1	1	1	1	1	0	1	0	(251/256) x Tp
1	1	1	1	1	0	1	1	(252/256) x Tp
1	1	1	1	1	1	0	0	(253/256) x Tp
1	1	1	1	1	1	0	1	(254/256) x Tp
			4	1	1	1	0	(255/256) x Tp
1	1	1	1				0	(200/200) x 1p

W30 to W37:S3/P3/G3 PWM duty data W30 to W37:S3/P3/G3 PWM duty data W40 to W47:S4/P4/G4 PWM duty data W50 to W57:S5/P5/G5 PWM duty data W60 to W67:S6/P6/G6 PWM duty data

# Display Data and Output Pin Correspondence 17. 1/4-Duty

1/4-Duty				
Output Pin <sup>(Note12)</sup>	COM1	COM2	COM3	COM4
S1/P1/G1	D1	D2	D3	D4
S2/P2/G2	D5	D6	D7	D8
S3/P3/G3	D9	D10	D11	D12
S4/P4/G4	D13	D14	D15	D16
S5/P5/G5	D17	D18	D19	D20
S6/P6/G6	D21	D22	D23	D24
S7	D25	D26	D27	D28
S8	D29	D30	D31	D32
S9	D33	D34	D35	D36
S10	D37	D38	D39	D40
S11	D41	D42	D43	D44
S12	D45	D46	D47	D48
S13	D49	D50	D51	D52
S14	D53	D54	D55	D56
S15	D57	D58	D59	D60
S16	D61	D62	D63	D64
S10	D01	D62	D03	D68
S17 S18				
	D69	D70	D71	D72
S19	D73	D74	D75	D76
S20	D77	D78	D79	D80
S21	D81	D82	D83	D84
S22	D85	D86	D87	D88
S23	D89	D90	D91	D92
S24	D93	D94	D95	D96
S25	D97	D98	D99	D100
S26	D101	D102	D103	D104
S27	D105	D106	D107	D108
S28	D109	D110	D111	D112
S29	D113	D114	D115	D116
S30	D117	D118	D119	D120
S31	D121	D122	D123	D124
S32	D125	D126	D127	D128
S33	D129	D130	D131	D132
S34	D133	D134	D135	D136
S35	D137	D138	D139	D140
S36	D141	D142	D143	D144
S37	D145	D146	D147	D148
S38	D149	D150	D151	D152
S39	D153	D154	D155	D156
S40	D155	D154	D159	D150
2.2		D158 D162		D160
S41	D161	-	D163	-
S42	D165	D166	D167	D168
S43	D169	D170	D171	D172
S44	D173	D174	D175	D176
S45	D177	D178	D179	D180
S46	D181	D182	D183	D184
S47	D185	D186	D187	D188
S48	D189	D190	D191	D192
S49	D193	D194	D195	D196
S50	D197	D198	D199	D200
S51	D201	D202	D203	D204
S52	D205	D206	D207	D208
S53	D209	D210	D211	D212
S54	D213	D214	D215	D216
S55	D217	D218	D219	D220
S56	D221	D222	D223	D224
S57	D225	D226	D227	D228
S58	D229	D230	D231	D232
S59	D233	D234	D235	D236
S60	D237	D238	D239	D240
S61	D241	D242	D243	D240
501	2611		-	
S62	D245	D246	D247	D248

Output pin <sup>(Note12)</sup>	COM1	COM2	COM3	COM4
S64	D253	D254	D255	D256
S65	D257	D258	D259	D260
S66	D261	D262	D263	D264
S67	D265	D266	D267	D268
S68	D269	D270	D271	D272
S69	D273	D274	D275	D276

(Note12) The Segment Output Port function is assumed to be selected for the output pins – S1/P1/G1 to S6/P6/G6.

To illustrate further, the states of the S21 output pin is given in the table below.

Display Data			State of S21 Output Pin			
D81	D82	D83	D84	·		
0	0	0	0	LCD Segments corresponding to COM1 to COM4 are OFF.		
0	0	0	1	LCD Segment corresponding to COM4 is ON.		
0	0	1	0	LCD Segment corresponding to COM3 is ON.		
0	0	1	1	LCD Segments corresponding to COM3 and COM4 are ON.		
0	1	0	0	LCD Segment corresponding to COM2 is ON.		
0	1	0	1	LCD Segments corresponding to COM2 and COM4 are ON.		
0	1	1	0	LCD Segments corresponding to COM2 and COM3 are ON.		
0	1	1	1	LCD Segments corresponding to COM2, COM3 and COM4 are ON.		
1	0	0	0	LCD Segment corresponding to COM1 is ON.		
1	0	0	1	LCD Segments corresponding to COM1 and COM4 are ON.		
1	0	1	0	LCD Segments corresponding to COM1 and COM3 are ON.		
1	0	1	1	LCD Segments corresponding to COM1, COM3 and COM4 are ON.		
1	1	0	0	LCD Segments corresponding to COM1 and COM2 are ON.		
1	1	0	1	LCD Segments corresponding to COM1, COM2, and COM4 are ON.		
1	1	1	0	LCD Segments corresponding to COM1, COM2, and COM3 are ON.		
1	1	1	1	LCD Segments corresponding to COM1 to COM 4 are ON.		

#### 2. 1/3-Duty

Output Pin <sup>(Note13)</sup> COM1         COM2           S1/P1/G1         D1         D2           S2/P2/G2         D4         D5           S3/P3/G3         D7         D8           S4/P4/G4         D10         D11           S5/P5/G5         D13         D14           S6/P6/G6         D16         D17           S7         D19         D20           S8         D22         D23           S9         D25         D26           S10         D28         D29           S11         D31         D32           S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47           S17         D49         D50	COM3 D3 D6 D9 D12 D15 D18 D21 D24 D27 D30 D33 D36 D39 D39 D42 D45 D48
S2/P2/G2         D4         D5           S3/P3/G3         D7         D8           S4/P4/G4         D10         D11           S5/P5/G5         D13         D14           S6/P6/G6         D16         D17           S7         D19         D20           S8         D22         D23           S9         D25         D26           S10         D28         D29           S11         D31         D32           S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D6           D9           D12           D15           D18           D21           D24           D27           D30           D33           D36           D39           D42           D42           D43
S3/P3/G3         D7         D8           S4/P4/G4         D10         D11           S5/P5/G5         D13         D14           S6/P6/G6         D16         D17           S7         D19         D20           S8         D22         D23           S9         D25         D26           S10         D28         D29           S11         D31         D32           S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D9 D12 D15 D18 D21 D24 D27 D30 D33 D36 D39 D42 D42 D45 D48
S4/P4/G4         D10         D11           S5/P5/G5         D13         D14           S6/P6/G6         D16         D17           S7         D19         D20           S8         D22         D23           S9         D25         D26           S10         D28         D29           S11         D31         D32           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D12 D15 D18 D21 D24 D27 D30 D33 D36 D39 D42 D45 D48
S5/P5/G5         D13         D14           S6/P6/G6         D16         D17           S7         D19         D20           S8         D22         D23           S9         D25         D26           S10         D28         D29           S11         D31         D32           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D15 D18 D21 D24 D27 D30 D33 D36 D39 D42 D45 D48
S6/P6/G6         D16         D17           S7         D19         D20           S8         D22         D23           S9         D25         D26           S10         D28         D29           S11         D31         D32           S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D18 D21 D24 D27 D30 D33 D36 D39 D42 D45 D48
S7         D19         D20           S8         D22         D23           S9         D25         D26           S10         D28         D29           S11         D31         D32           S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D21 D24 D27 D30 D33 D36 D39 D42 D45 D48
S8         D22         D23           S9         D25         D26           S10         D28         D29           S11         D31         D32           S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D24 D27 D30 D33 D36 D39 D42 D45 D48
S9         D25         D26           S10         D28         D29           S11         D31         D32           S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D27 D30 D33 D36 D39 D42 D45 D48
S10         D28         D29           S11         D31         D32           S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D30 D33 D36 D39 D42 D45 D48
S11         D31         D32           S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D33 D36 D39 D42 D45 D48
S12         D34         D35           S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D36 D39 D42 D45 D48
S13         D37         D38           S14         D40         D41           S15         D43         D44           S16         D46         D47	D39 D42 D45 D48
S14         D40         D41           S15         D43         D44           S16         D46         D47	D42 D45 D48
S15         D43         D44           S16         D46         D47	D45 D48
S16 D46 D47	D48
S16 D46 D47	
S17 D49 D50	
	D51
S18 D52 D53	D54
S19 D55 D56	D57
S20 D58 D59	D60
S21 D61 D62	D63
S22 D64 D65	D66
S23 D67 D68	D69
S24 D70 D71	D09 D72
S25 D73 D74	D75
S26 D76 D77	D78
S27 D79 D80	D81
S28 D82 D83	D84
S29 D85 D85	D87
S30 D88 D89	D90
S31 D91 D92	D93
S32 D94 D95	D96
S33 D97 D98	D99
S34 D100 D101	D102
S35 D103 D104	D105
S36 D106 D107	D108
S37 D109 D110	D111
S38 D112 D113	D114
S39 D115 D116	D117
S40 D118 D119	D120
S41 D121 D122	D123
S42 D124 D125	D126
S43 D127 D128	D129
S44 D130 D131	D132
S45 D133 D134	D135
S46 D136 D137	D138
S47 D139 D140	D141
S48 D142 D143	D144
S49 D145 D146	D147
S50 D148 D149	D147
S51 D151 D152	D153
	D156 D159
S54 D160 D161	D162
S55 D163 D164	D165
S56 D166 D167	D168
S57 D169 D170	D171
S58 D172 D173	D174
S59 D175 D176	D177
S60 D178 D179	D180
S61 D181 D182	D183
S62 D184 D185	D186
S63 D187 D188	D189

Output pin <sup>(Note13)</sup>	COM1	COM2	COM3
S64	D190	D191	D192
S65	D193	D194	D195
S66	D196	D197	D198
S67	D199	D200	D201
S68	D202	D203	D204
S69	D205	D206	D207

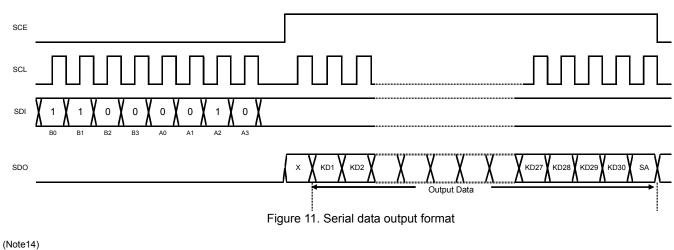
(Note13) The Segment Output Port function is assumed to be selected for the output pins - S1/P1/G1 to S6/P6/G6.

To illustrate further, the states of the S21 output pin is given in the table below.

Display Data		ata	State of S21 Output Pin		
D61	D62	D63			
0	0	0	LCD Segments corresponding to COM1, COM2 and COM3 are OFF.		
0	0	1	LCD Segment corresponding to COM3 is ON.		
0	1	0	LCD Segment corresponding to COM2 is ON.		
0	1	1	LCD Segments corresponding to COM2 and COM3 are ON.		
1	0	0	LCD Segment corresponding to COM1 is ON.		
1	0	1	LCD Segments corresponding to COM1 and COM3 are ON.		
1	1	0	LCD Segments corresponding to COM1 and COM2 are ON.		
1	1	1	LCD Segments corresponding to COM1, COM2 and COM3 are ON.		

#### **Serial Data Output**

17. When SCL is stopped at the low level<sup>(Note14)</sup>



1. X=Don't care

2. B0 to B3, A0 to A3: Serial Interface address

#### 2. When SCL is stopped at the high level<sup>(Note15)</sup>

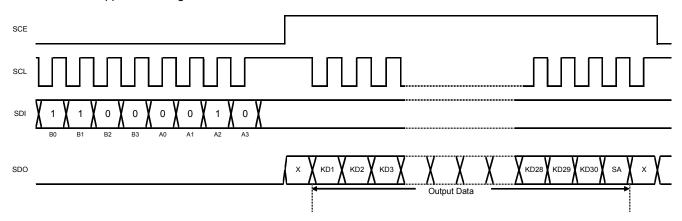


Figure 12. Serial Data Output Format

- (Note15) 1. X=Don't care
- 2. B0 to B3, A0 to A3: Serial Interface address
- 3. Serial Interface address: 43H
- 4. KD1 to KD30: Key data

5. SA: Sleep acknowledge data

6. If a key data read operation is executed when SDO is high, the read key data (KD1 to KD30) and sleep acknowledge data (SA) will be invalid.

#### Output Data

#### 17. KD1 to KD30: KEY DATA

When a key matrix of up to 30 keys is formed from the KS1 to KS6 output pins and the KI1 to KI5 input pins and one of those keys is pressed, the key output data corresponding to that key will be set to 1. The table shows the relationship between those pins and the key data bits.

Item	KI1	KI2	KI3	Kl4	KI5
KS1	KD1	KD2	KD3	KD4	KD5
KS2	KD6	KD7	KD8	KD9	KD10
KS3	KD11	KD12	KD13	KD14	KD15
KS4	KD16	KD17	KD18	KD19	KD20
KS5	KD21	KD22	KD23	KD24	KD25
KS6	KD26	KD27	KD28	KD29	KD30

2. SA: Sleep Acknowledge Data

This output data is set to the state when the key was pressed. In that case SDO will go to the low level. If serial data is input during this period and the mode is set (normal mode or sleep mode), the IC will be set to that mode. SA is set to 1 in the sleep mode and to 0 in the normal mode.

#### **Sleep Mode**

Sleep mode is set up by setting the BU0 to BU2 in the control data to 1. The segment outputs will all go low and the common outputs will also go low, and the oscillator on the OSC pin will stop (it will be started by a key press). This reduces power dissipation. This mode is cleared by sending control data with all the BU0 to BU2 set to 0. However, note that the S1/P1/G1 to S6/P6/G6 outputs can be used as general-purpose output ports according to the state of the P0 to P2 control data bits, even in sleep mode. (See the control data description for details.)

#### Key Scan Operation Function

#### 17. Key Scan Timing

The key scan period is 4608T(s). To reliably determine the on/off state of the keys, the BU97520AKV-M scans the keys twice and determines that a key has been pressed when the key data agrees. It outputs a key data read request (a low level on SDO) 9840T(s) after starting a key scan. If the key data does not agree and a key was pressed at that point, it scans the keys again. Thus the BU97520AKV-M cannot detect a key press shorter than 9840T(s).

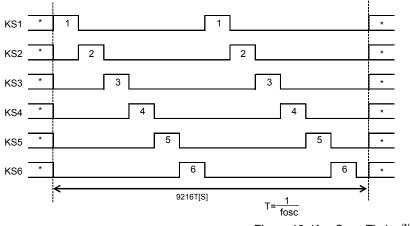


Figure 13. Key Scan Timing<sup>(Note16)</sup>

(Note16) \*: In sleep mode the high/low state of these pins is determined by the BU0 to BU2 bits in the control data. Key scan output signals are not output from pins that are set "L".

#### 2. In Normal Mode

The pins KS1 to KS6 are set "H".

When a key is pressed a key scan is started and the keys are scanned until all keys are released. Multiple key presses are recognized by determining whether multiple key data bits are set.

If a key is pressed for longer than 9840T(s) (Where T=1/fosc ) the BU97520AKV-M outputs a key data read request (a low level on SDO) to the controller. The controller acknowledges this request and reads the key data. However, if SCE is high during a serial data transfer, SDO will be set "H".

After the controller reads the key data, the key data read request is cleared (SDO is set high) and the BU97520AKV-M performs another key scan. Also note that SDO, being an open-drain output, requires a pull-up resistor (between 1 K $\Omega$  and 10K $\Omega$ ).

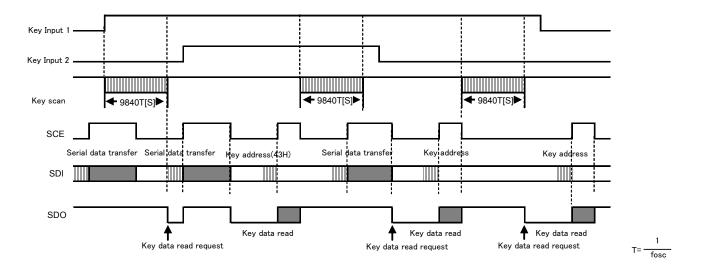


Figure 14. Key Scan Operation In Normal Mode

3. In Sleep Mode

The pins KS1 to KS6 are set to high or low by the BU0 to BU2 bits in the control data. (See the control data description for details.)

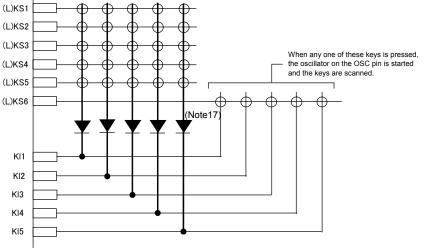
If a key on one of the lines corresponding to a KS1 to KS6 pin which is set high is pressed, the oscillator on the OSC pin is started and a key scan is performed. Keys are scanned until all keys are released. Multiple key presses are recognized by determining whether multiple key data bits are set.

If a key is pressed for longer than 9840T(s)(Where T=1/fosc) the BU97520AKV-M outputs a key data read request (a low level on SDO) to the controller. The controller acknowledges this request and reads the key data. However, if SCE is high during a serial data transfer, SDO will be set high.

After the controller reads the key data, the key data read request is cleared (SDO is set high) and the BU97520AKV-M performs another key scan. However, this does not clear sleep mode. Also note that SDO, being an open-drain output, requires a pull-up resistor (between 1 and  $10K\Omega$ ).

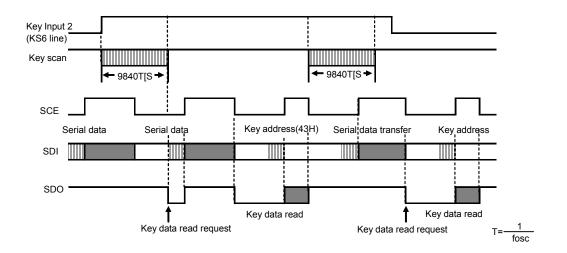
#### Sleep mode key scan example

Example: BU0=0, BU1=0, BU2=1 (sleep with only KS6 high)



(Note17)

These diodes are required to reliable recognize multiple key presses on the KS6 line when sleep mode state with only KS6 high, as in the above example. That is, these diodes prevent incorrect operations due to sneak currents in the KS6 key scan output signal when keys on the KS1 to KS5 lines are pressed at the same time.





#### **Multiple Key Press**

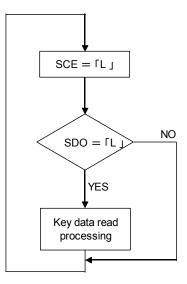
Although the BU97520AKV-M is capable of key scanning without inserting diodes for dual key presses, triple key presses on the KI1 to KI5 input pin lines, or multiple key presses on the KS1 to KS6 output pin lines, multiple presses other than these cases may result in keys that were not pressed recognized as having been pressed. Therefore, a diode must be inserted in series with each key. Applications that do not recognize multiple key presses of three or more keys should check the key data for three or more 1 bit and ignore such data.

#### **Controller Key Data Read Technique**

When the controller receives a key data read request from BU97520AKV-M, it performs a key data read acquisition operation using either the Timer Based Key Data Acquisition or the Interrupt Based Key Data Acquisition.

#### **Timer Based Key Data Acquisition Technique**

Under the Timer Based Key Data Acquisition Technique, the controller uses a timer to determine the states of the keys (ON or OFF) and read the key data. Please refer to the flowchart below.



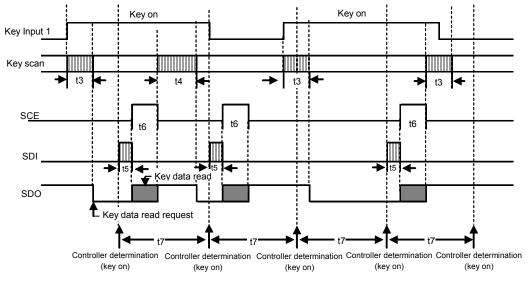
Key data read processing: Refer to "Serial Data Output"

#### Figure 16. Flowchart

In this technique, the controller uses a timer to determine key on/off states and read the key data. The controller must check the SDO state when SCE is low every t7 period without fail. If SDO is low, the controller recognizes that a key has been pressed and executes the key data read operation.

The period t7 in this technique must satisfy the following condition. T7>t4+t5+t6  $\ensuremath{\mathsf{T7}}$ 

If a key data read operation is executed when SDO is high, the read key data (KD1 to KD30) and sleep acknowledge data (SA) will be invalid.

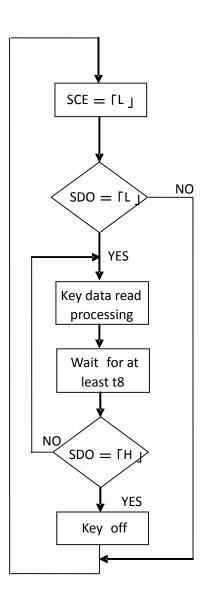


t3: Key scan execution time when the key data agreed for two key scans. (9840T(s))
t4: Key scan execution time when the key data did not agree for two key scans and the key scan was executed again. (19680T(s)) T = 1 / fosc
t5: Key address (43H) transfer time
t6: Key data read time

Figure 17. Timer Based Key Data Read Operation

#### Interrupt Based Key Data Acquisition Technique

Under the Interrupt Based Key Data Acquisition Technique, the controller uses interrupts to determine the state of the keys (ON or OFF) and read the key data. Please refer to the flow chart diagram below.

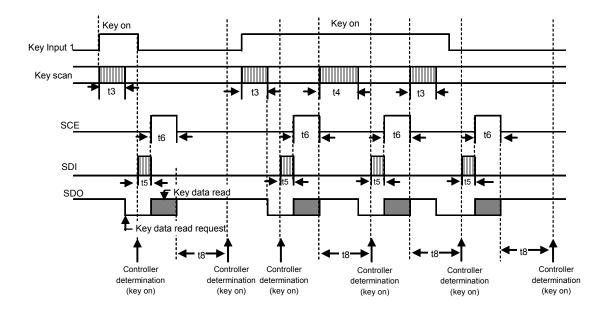


Key data read processing: Refer to "Serial Data Output"

Figure 18. Flowchart

In this technique, the controller uses interrupts to determine key on/off states and read the key data. The controller must check the SDO state when SCE is low. If SDO is low, the controller recognizes that a key has been pressed and executes the key data read operation. After that the next key on/off determination is performed after the time t8 has elapsed by checking the SDO state when SCE is low and reading the key data. The period t8 in this technique must satisfy t8 > t4.

If a key data read operation is executed when SDO is high, the read key data (KD1 to KD30) and sleep acknowledge data (SA) will be invalid.

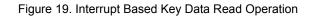


t3: Key scan execution time when the key data agreed for two key scans. (9840T(s))

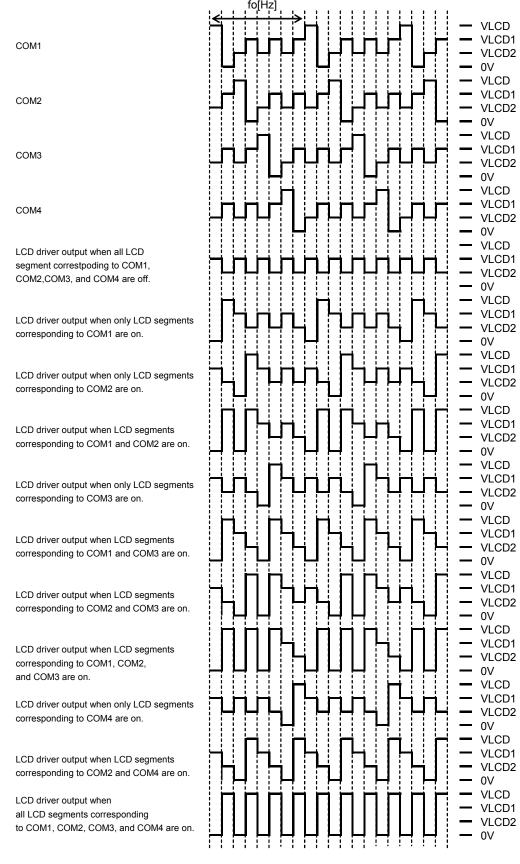
t4: Key scan execution time when the key data did not agree for two key scans and the key scan was executed again. (19680T(s))T = 1 / fosc

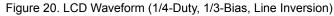
t5: Key address (43H) transfer time

t6: Key data read time



#### Output Waveform (Line Inversion 1/4-Duty 1/3-Bias Drive Scheme)





#### Output Waveform (Line Inversion 1/4-Duty 1/2-Bias Drive Scheme)

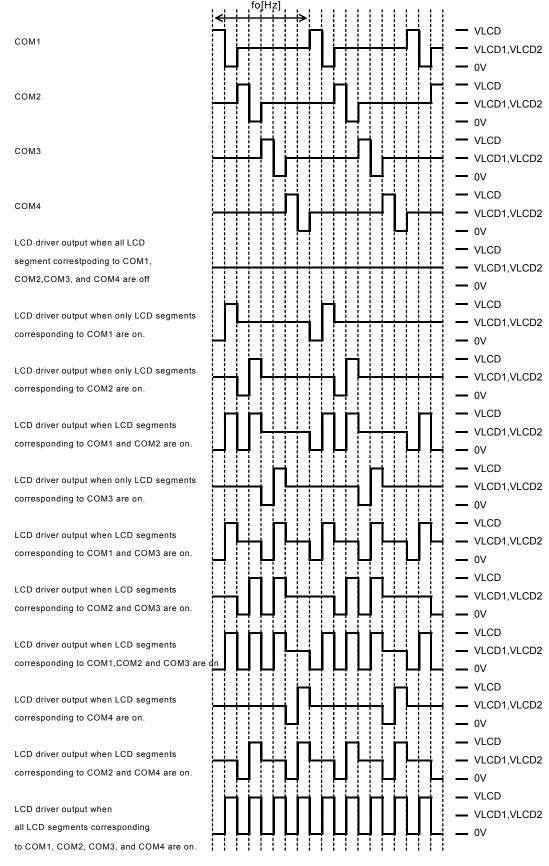


Figure 21. LCD Waveform (1/4-Duty, 1/2-Bias, Line Inversion)

#### Output Waveform (Line Inversion 1/3-Duty 1/3-Bias Drive Scheme)

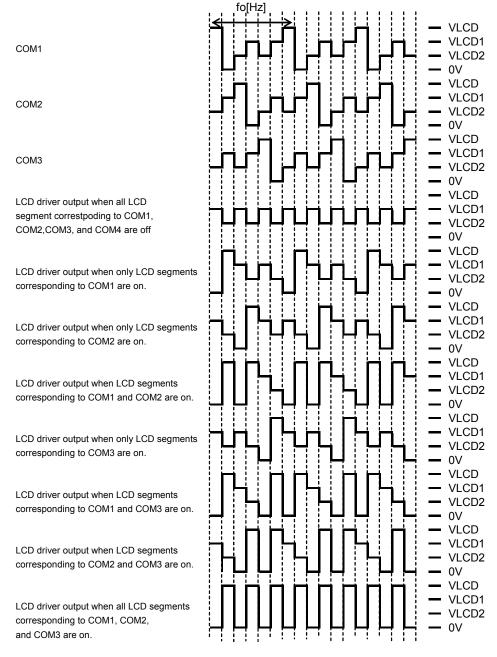


Figure 22. LCD Waveform (1/3-Duty, 1/3-Bias, Line Inversion)(Note18)

(Note18) COM4 function is same as COM1 at 1/3-Duty.

#### Output Waveform (Line Inversion 1/3-Duty 1/2-Bias Drive Scheme)

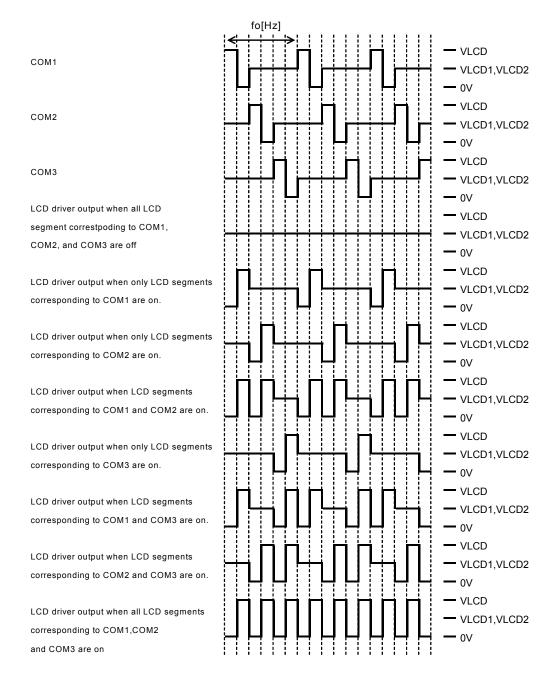
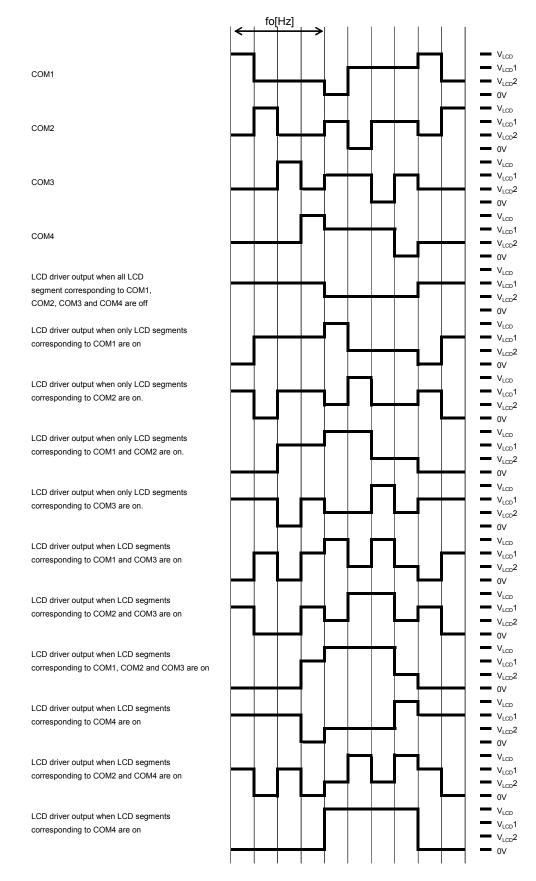
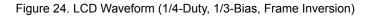


Figure 23. LCD Waveform (1/3-Duty, 1/2-Bias, Line Inversion)(Note19)

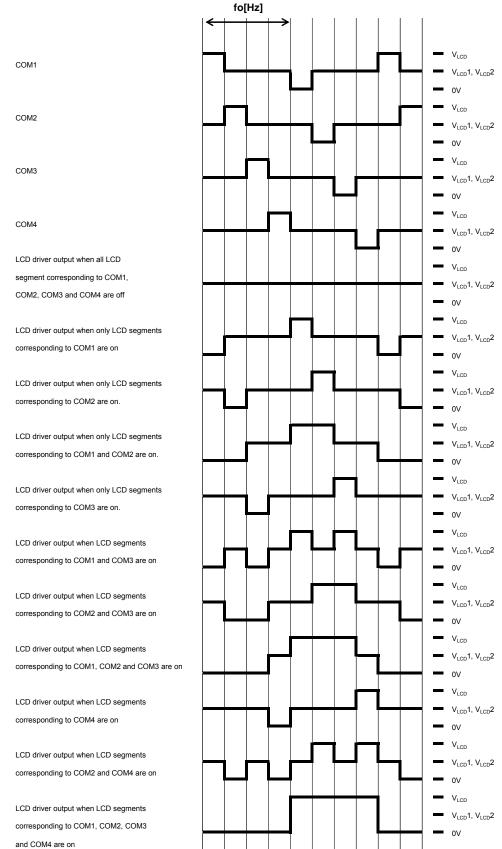
(Note19) COM4 function is same as COM1 at 1/3-Duty.

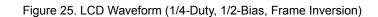
#### Output Waveform (Frame Inversion 1/4-Duty 1/3-Bias Drive Scheme)



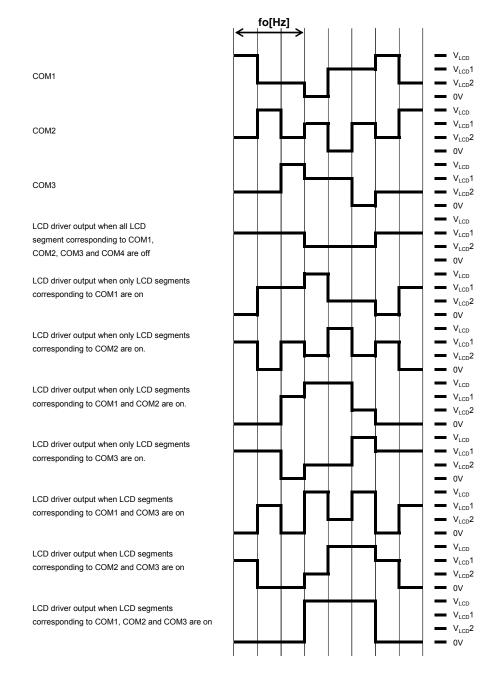


#### Output Waveform (Frame Inversion 1/4-Duty 1/2-Bias Drive Scheme)





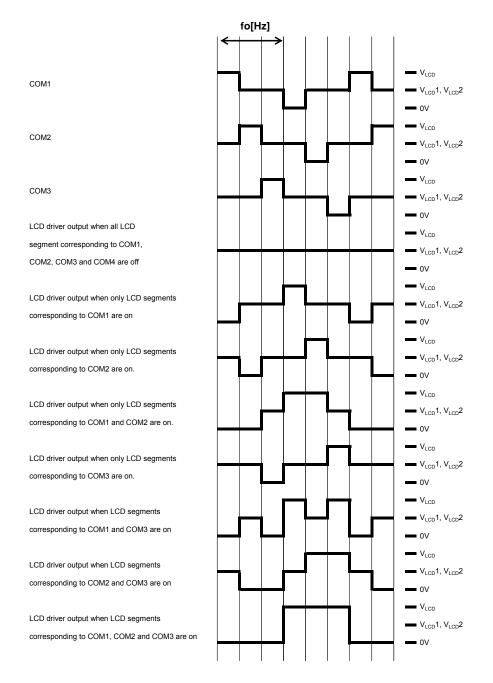
#### Output Waveform (Frame Inversion 1/3-Duty 1/3-Bias Drive Scheme)

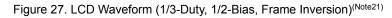




(Note20) COM4 function is same as COM1 at 1/3-Duty.

#### Output Waveform (Frame Inversion 1/3-Duty 1/2-Bias Drive Scheme)





(Note21) COM4 function is same as COM1 at 1/3-Duty.

#### **BU97520AKV-M**

#### **INHb Pin and Display Control**

Since the IC internal data (1/4-Duty: the display data D1 to D276 and the control data, 1/3-Duty: the display data D1 to D207 and the control data) is undefined when power is first applied, applications should set the INHb pin low at the same time as power is applied to turn off the display (This sets the S1/P1/G1 to S6/P6/G6, S7 to S69, COM1 to COM4 to the VSS level.) and during this period send serial data from the controller. The controller should then set the INHb pin high after the data transfer has completed. This procedure prevents meaningless displays at power on.

#### 17. 1/4-Duty

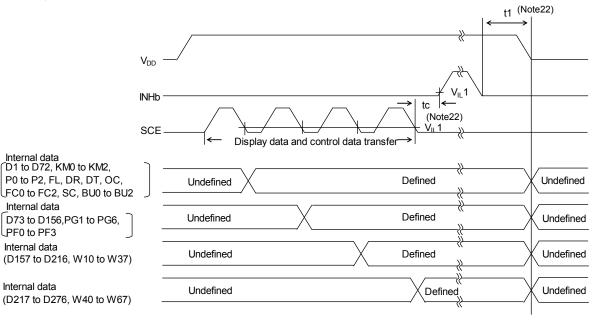


Figure 28. Power ON/OFF and INHb Control Sequence (1/4-Duty)

(Note22) t1≥0, tc: min 10us

2. 1/3-Duty

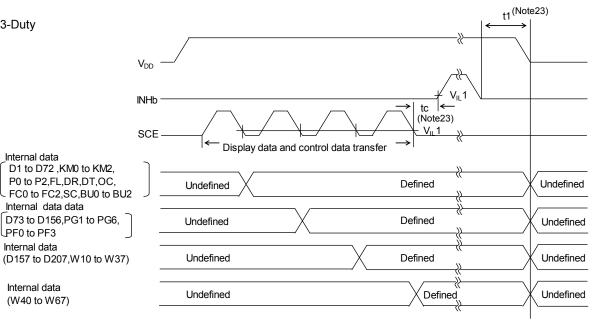


Figure 29. Power ON/OFF and INHb Control Sequence (1/3-Duty)

(Note23) t1≥0, tc: min 10us

#### **Oscillation Stabilization Time**

It must be noted that the oscillation of the internal oscillation circuit is unstable for a maximum of 100µs (oscillation stabilization time) after oscillation has started.

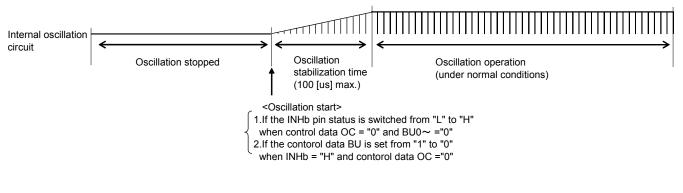


Figure 30. Oscillation Stabilization Time

#### Voltage Detection Type Reset Circuit (VDET)

The Voltage Detection Type Reset Circuit generates an output signal that resets the system when power is applied for the first time and when the power supply voltage drops (that is, for example, the power supply voltage is less than or equal to the power down detection voltage (VDET = 1.8V typ.). To ensure that this reset function works properly, it is recommended that a capacitor be connected to the power supply line so that both the power supply voltage (VDD) rise time when power is first applied and the power supply voltage (VDD) fall time when the voltage drops are at least 1ms.

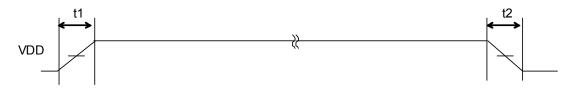


Figure 31. VDET Detection Timing

Power supply voltage VDD rise time: t1 > 1ms Power supply voltage VDD fall time: t2 > 1ms

#### **Reset Condition**

The internal status of BU97520AKV-M after power is applied is shown below.

Instruction	At Reset Condition		
Key Scan mode	[KM0,KM1,KM2]=[1,1,1]: Keyscan no use		
S1/P1/G1 to S6/P6/G6 Pin	[P0,P1,P2]=[0,0,0]:all segment output		
LCD Bias	DR=0:1/3-Bias		
LCD Duty	DT=0:1/4-Duty		
Inversion	FL=0:Line Inversion		
DISPLAY Frequency	[FC0,FC1,FC2]=[0,0,0]:fosc/12288		
Display Clock mode	OC=0:Internal oscillator		
LCD Display	SC=1:OFF		
Power Mode	BU0 to 2=[1,1,1]:Power saving mode		
PWM/GPO Output	PGx=0:PWM output(x=1 to 6)		
PWM Frequency	[PF0,PF1,PF2,PF3]=[0,0,0,0]: fosc /4096		
PWM Duty	[Wn0 to Wn7]=[0,0,0,0,0,0]		
	1/256xTp(n=1 to 6,Tp=1/fp)		

#### **Operational Notes**

#### 1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

#### 2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

#### 3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

#### 4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

#### 5. Thermal Consideration

Should by any chance the power dissipation rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. The absolute maximum rating of the Pd stated in this specification is when the IC is mounted on a 70mm x 70mm x 1.6mm glass epoxy board. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the Pd rating.

#### 6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

#### 7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

#### 8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

#### 9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

#### 10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

#### **Operational Notes – continued**

#### 11. Unused Input Pins

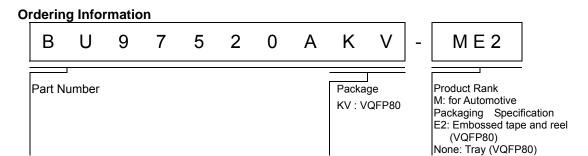
Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.

#### 12. Regarding the Input Pin of the IC

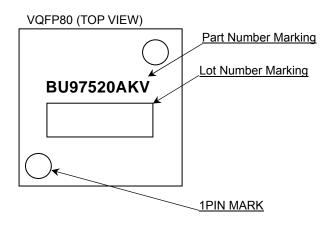
In the construction of this IC, P-N junctions are inevitably formed creating parasitic diodes or transistors. The operation of these parasitic elements can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions which cause these parasitic elements to operate, such as applying a voltage to an input pin lower than the ground voltage should be avoided. Furthermore, do not apply a voltage to the input pins when no power supply voltage is applied to the IC. Even if the power supply voltage is applied, make sure that the input pins have voltages within the values specified in the electrical characteristics of this IC.

#### 13. Data transmission

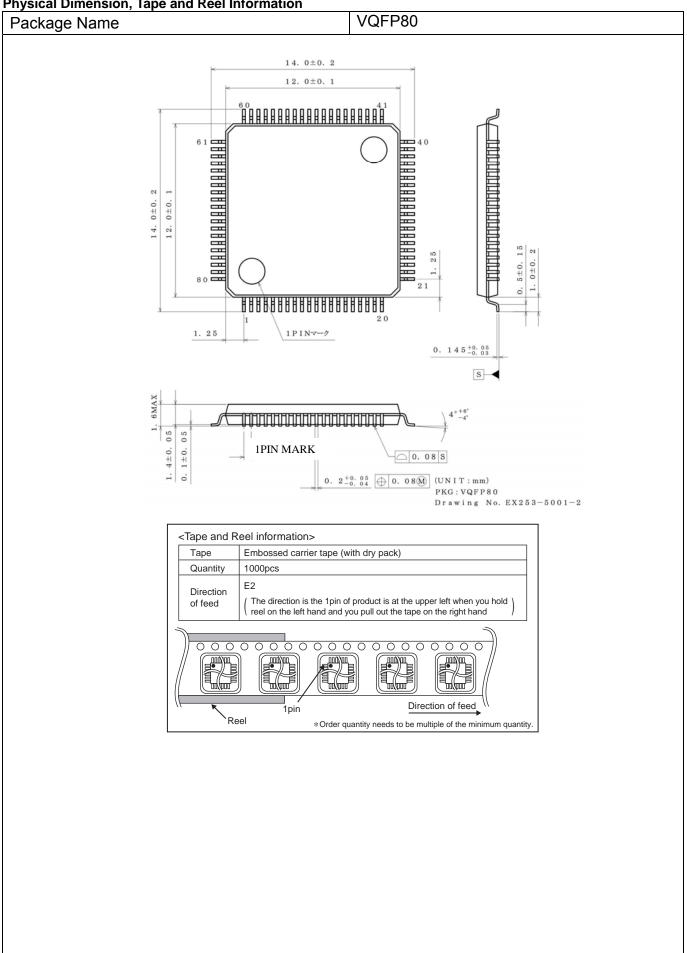
To refrain from data transmission is strongly recommended while power supply is rising up or falling down to prevent from the occurrence of disturbances on transmission and reception.



#### Marking Diagram



#### Physical Dimension, Tape and Reel Information



#### **Revision History**

Version	Date	Description		
001	14.Feb.2014	New Release		
002	26.Feb.2014	Correction of erroneous descriptions in Figure 8 and 10.		
003	24.Mar.2014	Change the condition of VIH1 and VIH2 in page 3		
004	17.Apr.2014	rrection of erroneous descriptions in Figure 3. rrection of erroneous chapter number.		
005	17.Feb.2015	Modify Note number. Add Note on AEC-Q100 Qualified in page 1. Add External Clock Duty Min limit in page 4. Modify Data Setup Time Min limit in page 4. Modify Data Hold Time Min limit in page 4. Modify SCE Wait Time Min limit in page 4. Modify SCE Setup Time Min limit in page 4. Modify SCE Hold Time Min limit in page 4. Modify Low-level Clock Pulse Width Min limit in page 4. Modify SDO Output Delay Time CL description in page 4. Modify SDO Nise Time CL description in page 4. Add Clock Cycle Time in page 4. Add Clock Cycle Time in page 4. Add Clock Cycle Time in page 4. Add SDO signal, tccyc and tclwr on Figure5 Serial Interface Timing in page 5. Modify reference level of tchw to VIL1 from 50% on Figure5 Serial Interface Timing in page 5. Modify reference level of tchw to VIL1 from 50% on Figure5 Serial Interface Timing in page 5. Modify reference level of tchw to VIL1 from 50% on Figure5 Serial Interface Timing in page 5. Modify reference level of tchw to VIL1 from 50% on Figure5 Serial Interface Timing in page 5. Modify reference level of tchw to VIL1 from 50% on Figure5 Serial Interface Timing in page 5. Modify reference level of tchw to VIL1 from 50% on Figure5 Serial Interface Timing in page 5. Modify reference level of tchw to VIL1 from 50% on Figure5 Serial Interface Timing in page 5. Modify reference level of tchw to VIL1 from 50% on Figure5 Serial Interface Timing in page 5. Delete tcp on Figure5 Serial Interface Timing(1.When SCL is stopped at the low level) in page 5. Delete tcs on Figure5 Serial Interface Timing(2.When SCL is stopped at the high level) in page 5. Add packing specification for tray in page 39 and page 40.		
006	19.Mar.2015	Modify INHb Handling when unused of Pin Description in page 6.		

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(Note1) Medical Equipment Classification of the Specific Application	ons
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JAPAN	USA	EU	CHINA	
CLASSII		CLASS II b	CLASSII	
CLASSⅣ	CLASSⅢ	CLASSⅢ	CLASSII	

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  - [h] Use of the Products in places subject to dew condensation
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